

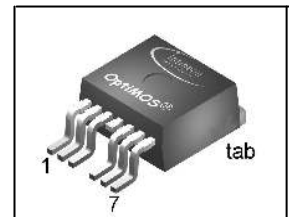
**OptiMOS® Power-Transistor**
**Feature**

- N-Channel
- Enhancement mode
- High Current Rating
- Low On-Resistance  $R_{DS(on)}$
- 175°C operating temperature
- Avalanche rated
- $dv/dt$  rated

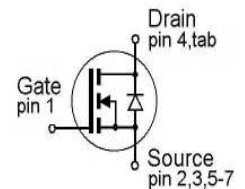
**Product Summary**

|              |     |    |
|--------------|-----|----|
| $V_{DS}$     | 40  | V  |
| $R_{DS(on)}$ | 2.9 | mΩ |
| $I_D$        | 160 | A  |

P- TO263 -7-3



| Type           | Package       | Ordering Code | Marking |
|----------------|---------------|---------------|---------|
| SPB160N04S2-03 | P- TO263 -7-3 | Q67060-S6123  | P2N0403 |


**Maximum Ratings, at  $T_j = 25\text{ °C}$ , unless otherwise specified**

| Parameter  | Symbol              | Value       | Unit              |
|--|---------------------|-------------|-------------------|
| Continuous drain current <sup>1)</sup><br>$T_C=25\text{ °C}$   | $I_D$               | 160<br>160  | A                 |
| Pulsed drain current<br>$T_C=25\text{ °C}$   | $I_{D\text{ puls}}$ | 640         |                   |
| Avalanche energy, single pulse<br>$I_D=80\text{ A}$ , $V_{DD}=25\text{ V}$ , $R_{GS}=25\text{ Ω}$                                | $E_{AS}$            | 810         | mJ                |
| Repetitive avalanche energy, limited by $T_{jmax}^{2)}$  | $E_{AR}$            | 30          |                   |
| Reverse diode $dv/dt$<br>$I_S=160\text{ A}$ , $V_{DS}=44\text{ V}$ , $di/dt=200\text{ A}/\mu\text{s}$ , $T_{jmax}=175\text{ °C}$ | $dv/dt$             | 6           | kV/ $\mu\text{s}$ |
| Gate source voltage  | $V_{GS}$            | $\pm 20$    | V                 |
| Power dissipation<br>$T_C=25\text{ °C}$  | $P_{tot}$           | 300         | W                 |
| Operating and storage temperature  | $T_j, T_{stg}$      | -55... +175 | °C                |
| IEC climatic category; DIN IEC 68-1  |                     | 55/175/56   |                   |

**Thermal Characteristics**

| Parameter   | Symbol     | Values |      |          | Unit |
|---|------------|--------|------|----------|------|
|   |            | min.   | typ. | max.     |      |
| <b>Characteristics</b>  |            |        |      |          |      |
| Thermal resistance, junction - case   | $R_{thJC}$ | -      | 0.3  | 0.5      | K/W  |
| Thermal resistance, junction - ambient, leaded  | $R_{thJA}$ | -      | -    | 62       |      |
| SMD version, device on PCB:<br>@ min. footprint<br>@ 6 cm <sup>2</sup> cooling area <sup>3)</sup> | $R_{thJA}$ | -      | -    | 62<br>40 |      |

**Electrical Characteristics, at  $T_j = 25\text{ }^\circ\text{C}$ , unless otherwise specified**

| Parameter   | Symbol        | Values |           |          | Unit       |
|---|---------------|--------|-----------|----------|------------|
|   |               | min.   | typ.      | max.     |            |
| <b>Static Characteristics</b>   |               |        |           |          |            |
| Drain-source breakdown voltage<br>$V_{GS}=0V, I_D=1mA$  | $V_{(BR)DSS}$ | 40     | -         | -        | V          |
| Gate threshold voltage, $V_{GS} = V_{DS}$<br>$I_D = 250\mu A$   | $V_{GS(th)}$  | 2.1    | 3         | 4        |            |
| Zero gate voltage drain current<br>$V_{DS}=40V, V_{GS}=0V, T_j=25^\circ C$<br>$V_{DS}=40V, V_{GS}=0V, T_j=125^\circ C^2)$ | $I_{DSS}$     | -      | 0.01<br>1 | 1<br>100 | $\mu A$    |
| Gate-source leakage current<br>$V_{GS}=20V, V_{DS}=0V$  | $I_{GSS}$     | -      | 1         | 100      | nA         |
| Drain-source on-state resistance<br>$V_{GS}=10V, I_D=80A$   | $R_{DS(on)}$  | -      | 2.3       | 2.9      | m $\Omega$ |

<sup>1</sup>Current limited by bondwire ; with an  $R_{thJC} = 0.5K/W$  the chip is able to carry  $I_D = 235A$  at  $25^\circ C$ , for detailed information see app.-note ANPS071E available at [www.infineon.com/optimos](http://www.infineon.com/optimos)

<sup>2</sup>Defined by design. Not subject to production test.

<sup>3</sup>Device on 40mm\*40mm\*1.5mm epoxy PCB FR4 with 6cm<sup>2</sup> (one layer, 70  $\mu m$  thick) copper area for drain connection. PCB is vertical without blown air.

**Electrical Characteristics**

| Parameter | Symbol | Conditions | Values |      |      | Unit |
|-----------|--------|------------|--------|------|------|------|
|           |        |            | min.   | typ. | max. |      |

**Dynamic Characteristics**

|                              |              |  |    |      |      |    |
|------------------------------|--------------|--|----|------|------|----|
| Transconductance             | $g_{fs}$     | $V_{DS} \geq 2 \cdot I_D \cdot R_{DS(on)max}$ ,<br>$I_D = 160A$          | 90 | 180  | -    | S  |
| Input capacitance            | $C_{iss}$    | $V_{GS} = 0V$ , $V_{DS} = 25V$ ,<br>$f = 1MHz$                           | -  | 5500 | 7320 | pF |
| Output capacitance           | $C_{oss}$    |  | -  | 1900 | 2530 |    |
| Reverse transfer capacitance | $C_{rss}$    |  | -  | 500  | 750  |    |
| Turn-on delay time           | $t_{d(on)}$  | $V_{DD} = 20V$ , $V_{GS} = 10V$ ,<br>$I_D = 160A$ ,<br>$R_G = 2.2\Omega$ | -  | 21   | 32   | ns |
| Rise time                    | $t_r$        |  | -  | 50   | 75   |    |
| Turn-off delay time          | $t_{d(off)}$ |  | -  | 61   | 92   |    |
| Fall time                    | $t_f$        |  | -  | 40   | 60   |    |

**Gate Charge Characteristics**

|                       |                 |  |   |     |     |    |
|-----------------------|-----------------|--|---|-----|-----|----|
| Gate to source charge | $Q_{gs}$        | $V_{DD} = 32V$ , $I_D = 160A$                            | - | 25  | 30  | nC |
| Gate to drain charge  | $Q_{gd}$        |  | - | 50  | 75  |    |
| Gate charge total     | $Q_g$           | $V_{DD} = 32V$ , $I_D = 160A$ ,<br>$V_{GS} = 0$ to $10V$ | - | 135 | 170 |    |
| Gate plateau voltage  | $V_{(plateau)}$ | $V_{DD} = 32V$ , $I_D = 160A$                            | - | 5.3 | -   | V  |

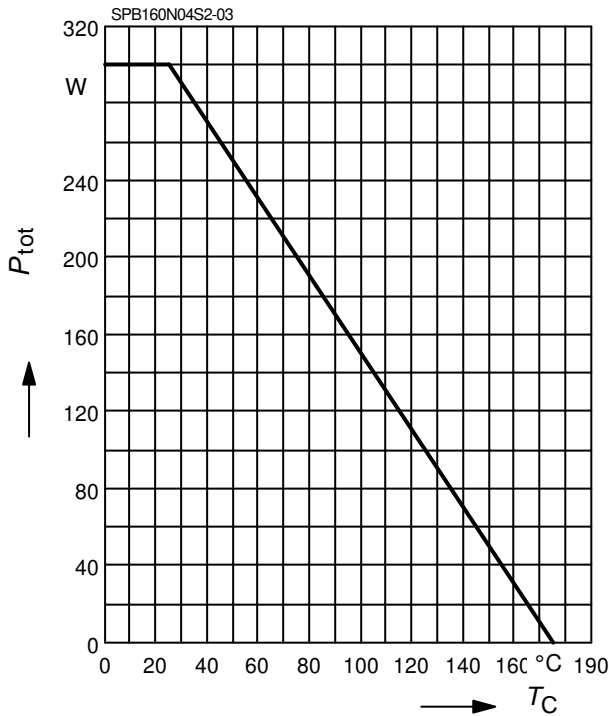
**Reverse Diode**

|  |          |   |   |     |     |    |
|--|----------|---|---|-----|-----|----|
| Inverse diode continuous forward current | $I_S$    | $T_C = 25^\circ C$                                    | - | -   | 160 | A  |
| Inv. diode direct current, pulsed        | $I_{SM}$ |   | - | -   | 640 |    |
| Inverse diode forward voltage            | $V_{SD}$ | $V_{GS} = 0V$ , $I_F = 80A$                           | - | 0.9 | 1.3 | V  |
| Reverse recovery time                    | $t_{rr}$ | $V_R = 20V$ , $I_F = I_S$ ,<br>$di_F/dt = 100A/\mu s$ | - | 60  | 75  | ns |
| Reverse recovery charge                  | $Q_{rr}$ |   | - | 100 | 125 |    |

### 1 Power dissipation

$$P_{tot} = f(T_C)$$

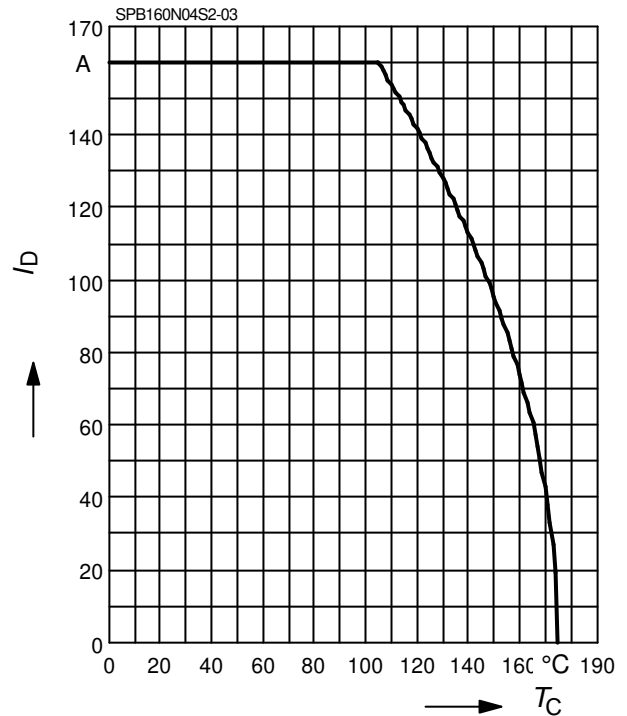
parameter:  $V_{GS} \geq 6 \text{ V}$



### 2 Drain current

$$I_D = f(T_C)$$

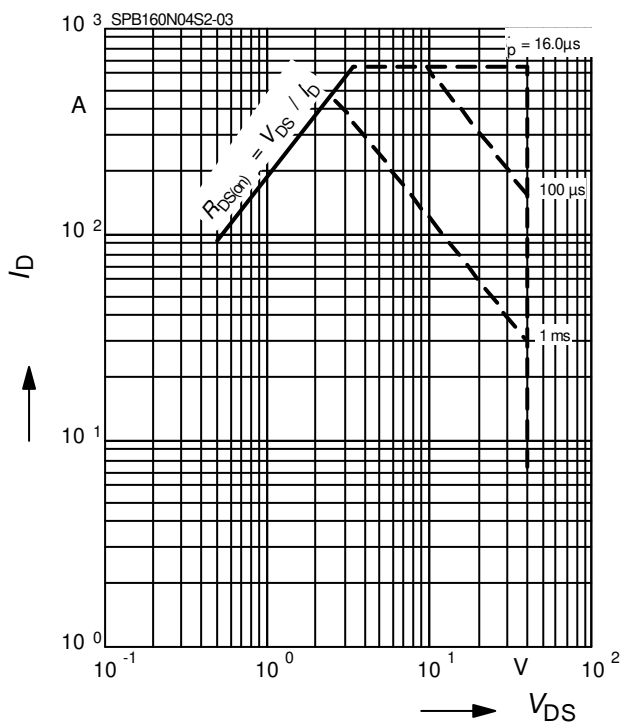
parameter:  $V_{GS} \geq 10 \text{ V}$



### 3 Safe operating area

$$I_D = f(V_{DS})$$

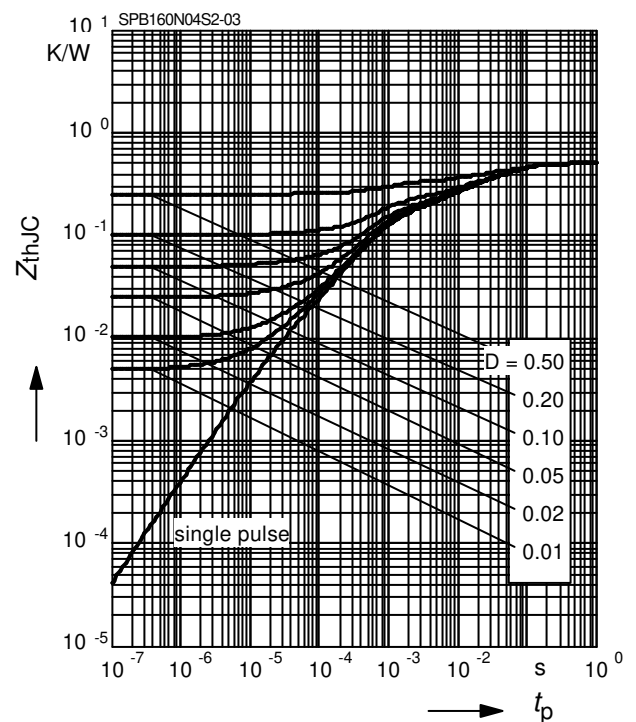
parameter:  $D = 0, T_C = 25^\circ\text{C}$



### 4 Max. transient thermal impedance

$$Z_{thJC} = f(t_p)$$

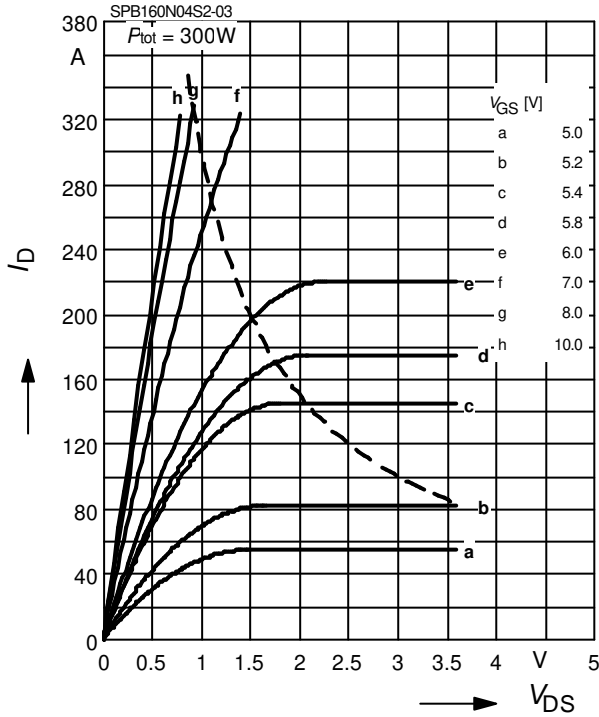
parameter:  $D = t_p/T$



**5 Typ. output characteristic**

$I_D = f(V_{DS}); T_j = 25^\circ\text{C}$

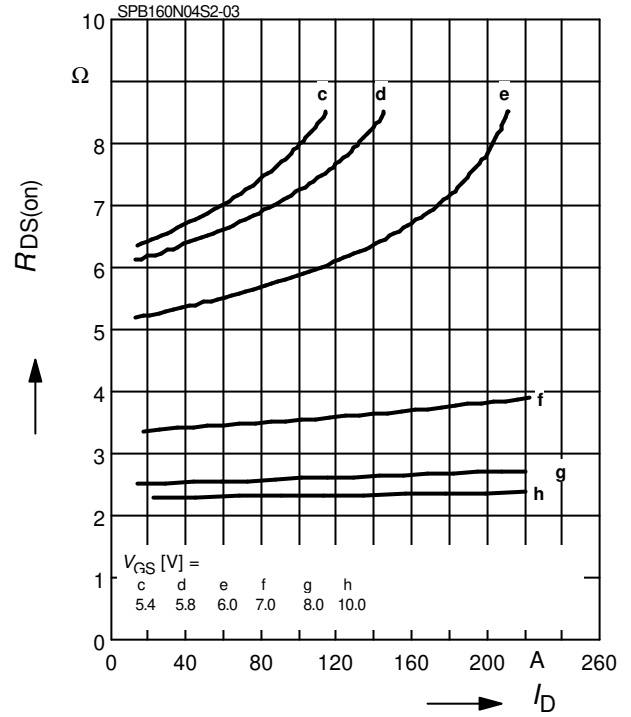
parameter:  $t_p = 80 \mu\text{s}$



**6 Typ. drain-source on resistance**

$R_{DS(on)} = f(I_D)$

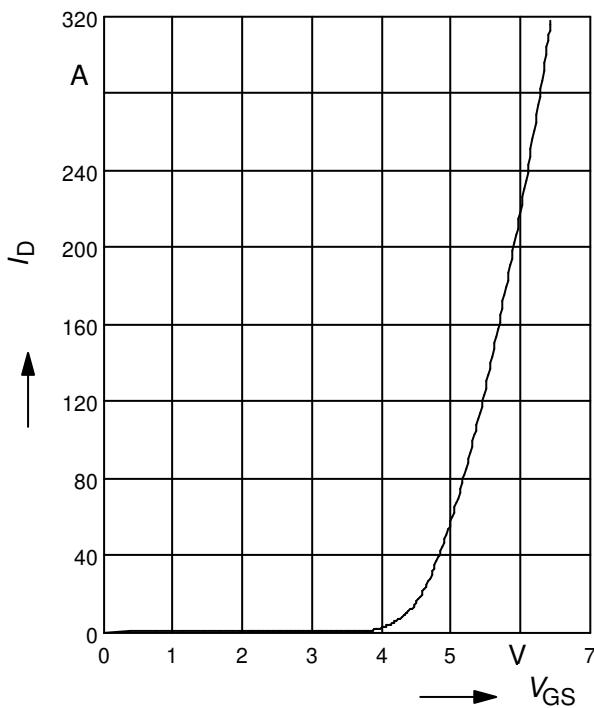
parameter:  $V_{GS}$



**7 Typ. transfer characteristics**

$I_D = f(V_{GS}); V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$

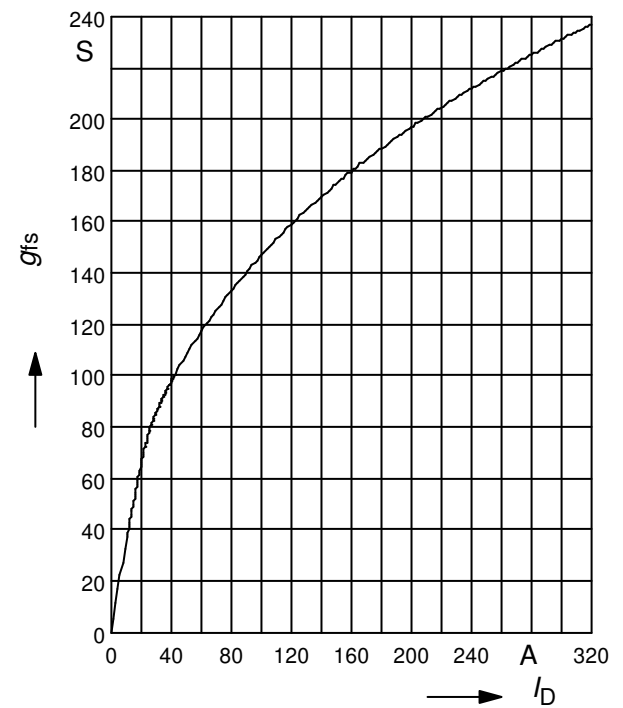
parameter:  $t_p = 80 \mu\text{s}$



**8 Typ. forward transconductance**

$g_{fs} = f(I_D); T_j = 25^\circ\text{C}$

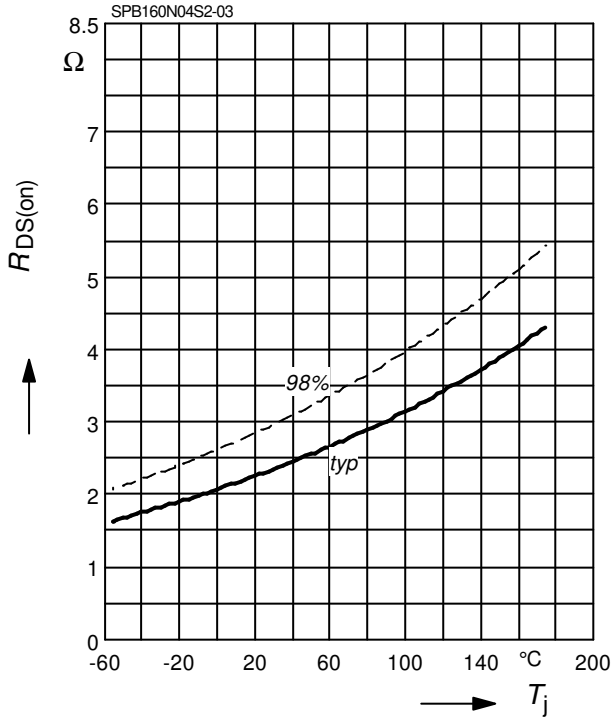
parameter:  $g_{fs}$



**9 Drain-source on-state resistance**

$$R_{DS(on)} = f(T_j)$$

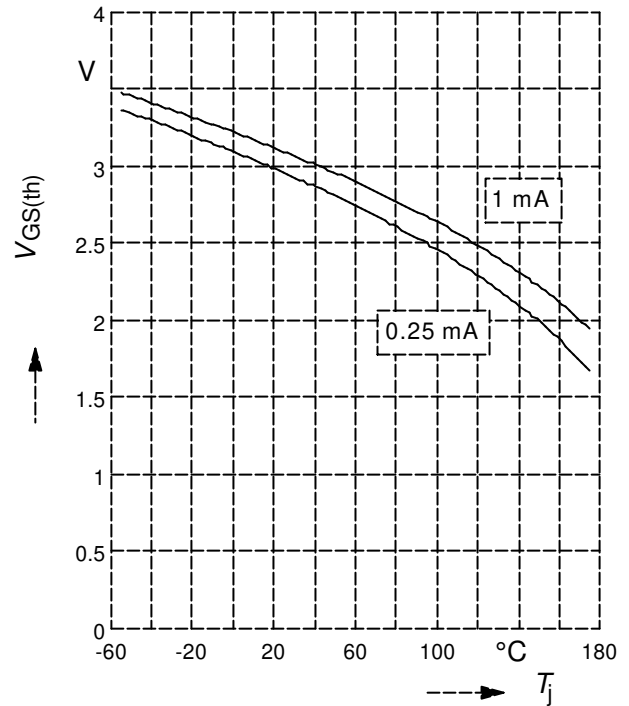
parameter :  $I_D = 80 \text{ A}$ ,  $V_{GS} = 10 \text{ V}$



**10 Typ. gate threshold voltage**

$$V_{GS(th)} = f(T_j)$$

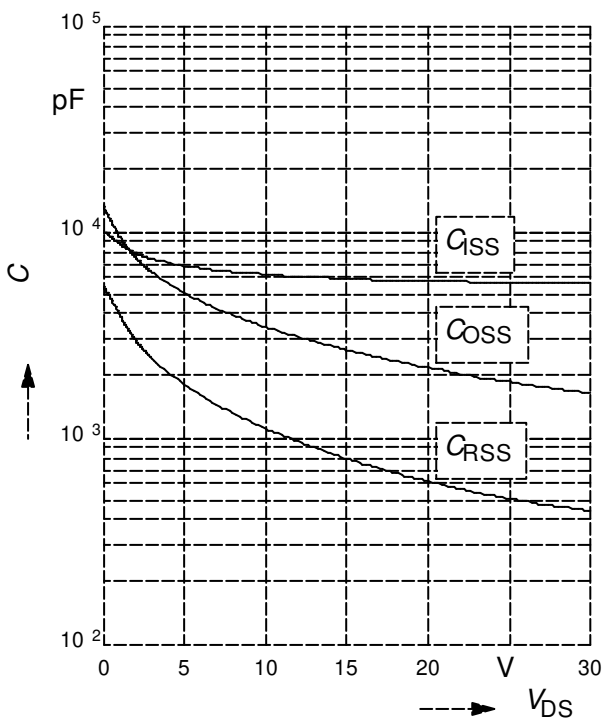
parameter:  $V_{GS} = V_{DS}$



**11 Typ. capacitances**

$$C = f(V_{DS})$$

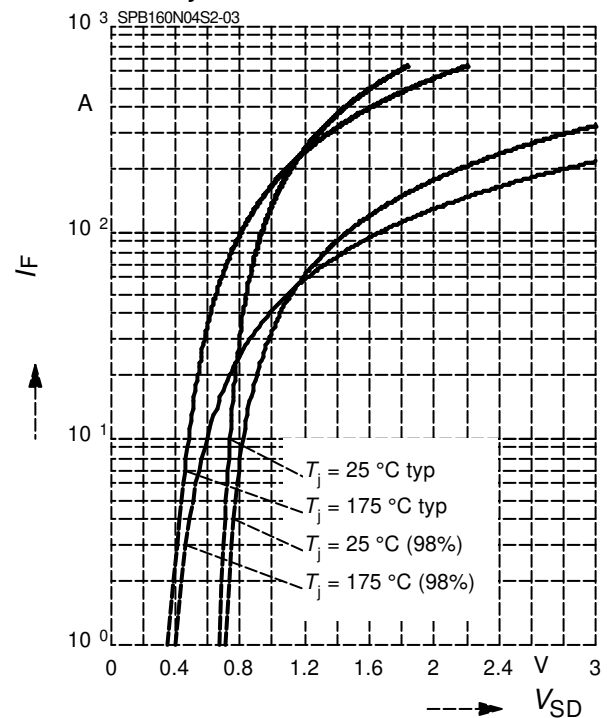
parameter:  $V_{GS}=0\text{V}$ ,  $f=1 \text{ MHz}$



**12 Forward character. of reverse diode**

$$I_F = f(V_{SD})$$

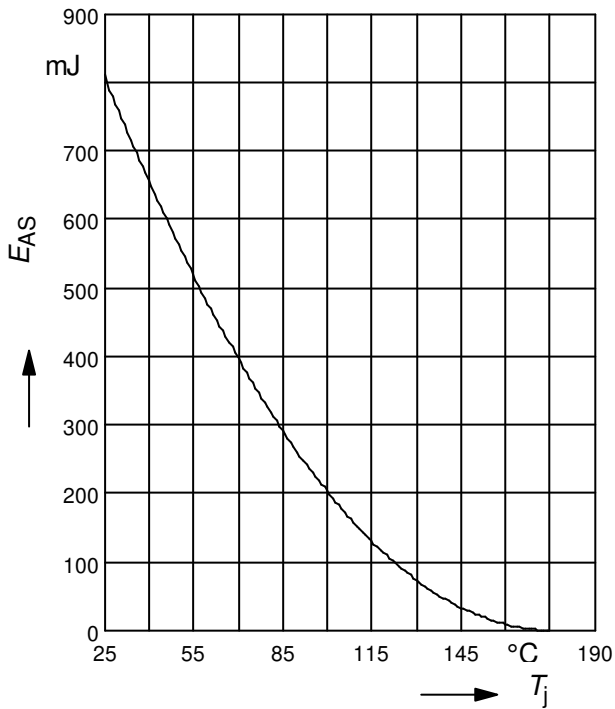
parameter:  $T_j$ ,  $t_p = 80 \mu\text{s}$



**13 Typ. avalanche energy**

$$E_{AS} = f(T_j)$$

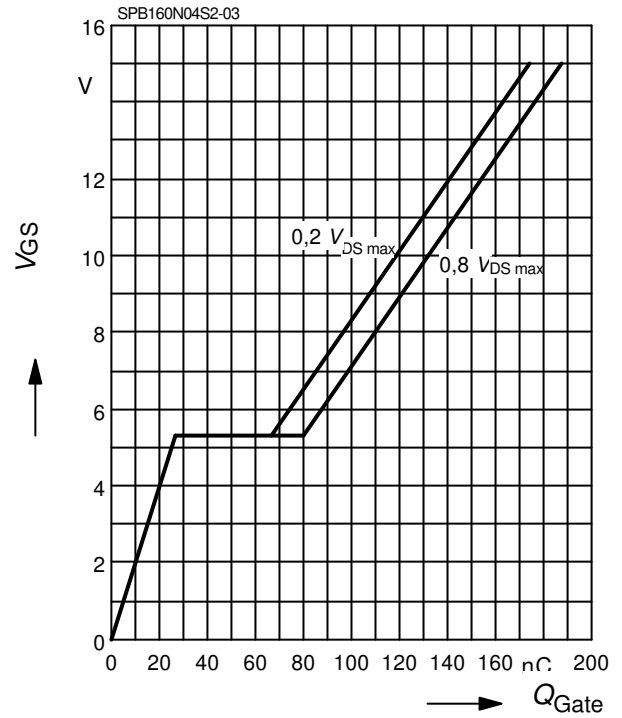
par.:  $I_D = 80 \text{ A}$ ,  $V_{DD} = 25 \text{ V}$ ,  $R_{GS} = 25 \Omega$



**14 Typ. gate charge**

$$V_{GS} = f(Q_{Gate})$$

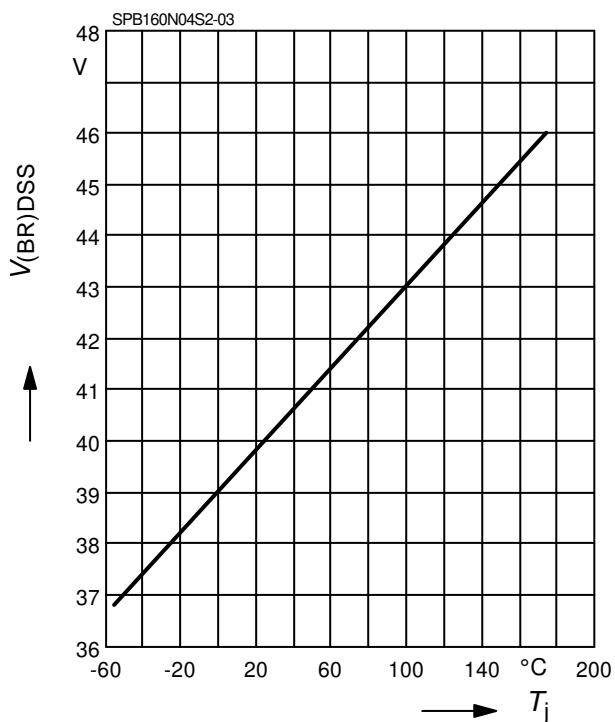
parameter:  $I_D = 160 \text{ A}$  pulsed



**15 Drain-source breakdown voltage**

$$V_{(BR)DSS} = f(T_j)$$

parameter:  $I_D = 10 \text{ mA}$



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**Further information**

Please notice that the part number is BSPB160N04S2-03, for simplicity the device is referred to by the term SPB160N04S2-03 throughout this documentation.